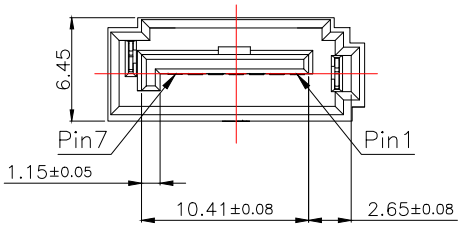
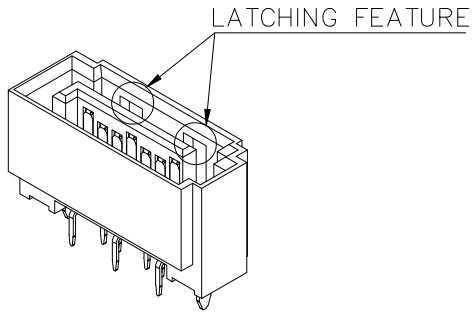
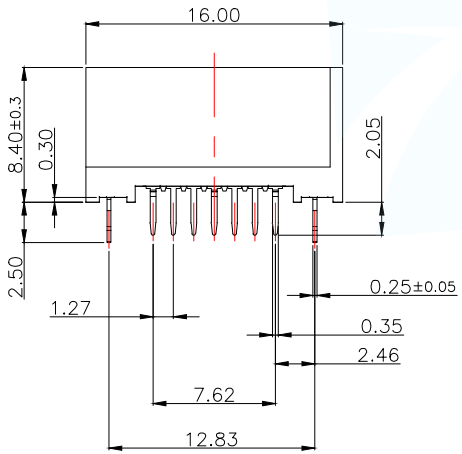
ROHS Compliant

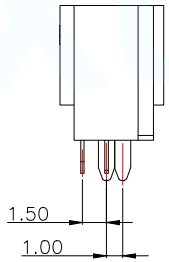
MAPX	MODIFICATION	DATE	DRAW	APPROVE

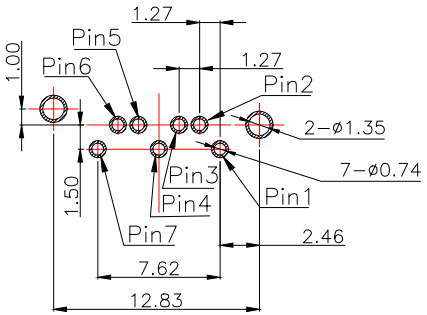




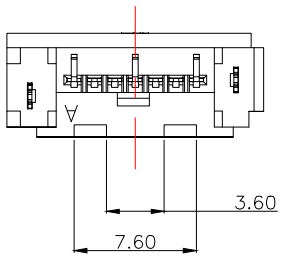
1.MATERIAL SPECIFICATION,
1-1.HOUSING:SEE TABLE;
1-2.CONTACT:BRASS C2680;
1-3.HOOK:BRASS C2680;
2.PLATING SPECIFICATION,
2-1.CONTACT:
UNDER PLATING:Ni 50u" Min PLATED OVER ALL;
CONTACT AREA: SEE TABLE;
SOLDER TAIL: MATTE TIN 100u" Min PLATED,
2-2.HOOK: MATTE TIN 100u" Min PLATED OVER Ni 50u" Min.
3.MECHANICAL PERFORMANCE,
3-1.INSERTION FORCE:45N Max
3-2.REMOVAL FORCE:10N Min
3-3.DURABILITY:50 CYCLES
4.ELECTRICAL PERFORMANCE,
4-1.CURRENT RATING:1.5A Max
4-2.INSULATION RESISTANCE:1000 MEGAOHMS Min.
4-3.DIELECTRIC WITHSTAND VOLTAGE:500VRMS AT SEA LEVEL







RECOMMENDED P.C.B. LAYOUT(TOP VIEW)
THICKNESS:1.6mm; TOLERANCE ±0.05mm



MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co,Ltd			
UNLESS OTHERWISE SPECIFED TOLERANCES			TITLE:SATA2.0 7Pin CONN. 固定直脚 PH1.5 端子反向		
			PAR	SATA-602-M07S1BY-A	
DECIMALS:	ANGLES:		DWN		
X.X±0.30	X.°±5°		CHKD		
X.XX±0.20	X.X°±2°		APVD		
X.XXX±0.10	X.XX°±1°	CUSTOMER COPY	SCALE N:A	UNIT:MM	
			SIZE:A4	SHEET:1F1	REV:A

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XUNPU:

MU-103-ARW64 PHB2.0-02-20PZZ WAFER-XH2.54-4PWZ-H62 FPC-0.5AS-5PWCR-H20
WAFER-PH2.0-6PWB RJ45-005-014-11 WAFER-PH2.0-8PLB WAFER-VH3.96-4PLB
WAFER-WBM4.2-16PJK-GB FPC-0.5FX-14PWCR-H20 HDMI-212L WAFER-GH1.25-6PLB
WAFER-MX1.25B-8PWB WAFER-PH2.0-3PWB FPC-0.5HF-10PWBR-H20 FPC-1.0HF-4PWAR-H20
SMA-KWE-323C-H13X23-LW WAFER-PH2.0-2PJK FPC-1.0AX-4PWCR-H25 WAFER-PH2.0-11PZZ
FPC-0.5AX-24PWCR-H20 FPC-0.5FX-4PWBH15 TYPEC-304YDSW-ACP16 DC-031A-A100 FPC-0.5AL-6PB
FPC-0.5AX-30PWCR-H20 FPC-0.5FX-16PWCR-H20 FPC-0.5FX-20PWBH15 FPC-0.5FX-4PWCR-H20
FPC-1.0AX-14PWCR-H25